SDIA6028 TYPE

FEATURE

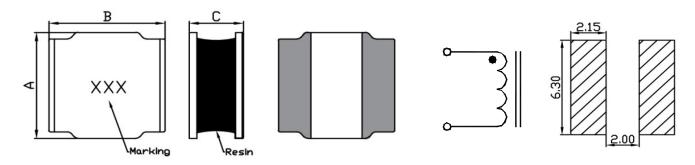
1. Low profile (Height: 2.80mm Max)

Applications

1. DC-DC in electric equipment

Shape and Dimension





 $A=6.00\pm0.40$ m/m; $B=6.00\pm0.40$ m/m; C=2.80m/m MAX

Specification

Part Number	L(uH)	Marking	DCR(mΩMAX)	Isat(A)	Irms(A)
SDIA6028-1R0N	1.0±30%	1R0	17.0	7.60	5.20
SDIA6028-1R5N	1.5±30%	1R5	20.8	6.30	4.80
SDIA6028-2R2N	2.2±30%	2R2	33.8	5.40	4.00
SDIA6028-2R7N	2.7±30%	2R7	35.0	4.90	3.70
SDIA6028-3R3N	3.3±30%	3R3	36.4	4.30	3.50
SDIA6028-4R7N	4.7±30%	4R7	49.4	3.70	3.20
SDIA6028-6R0N	6.0±30%	6R0	58.5	3.30	2.80
SDIA6028-6R8N	6.8±30%	6R8	65.0	3.10	2.70
SDIA6028-100M	10±20%	100	84.5	2.50	2.30
SDIA6028-150M	15±20%	150	123.5	2.00	1.80
SDIA6028-220M	22±20%	220	175.5	1.60	1.50
SDIA6028-330M	33±20%	330	360.0	1.30	1.40
SDIA6028-470M	47±20%	470	416.0	1.10	1.00
SDIA6028-680M	68±20%	680	546.0	0.98	0.90
SDIA6028-101M	100±20%	101	780.0	0.82	0.80

Note1. Measurement frequency of Inductance value : at 100KHz at 25°C

Note2. Inductance Tolerance: N: ±30%; M: ±20%

Note3. Isat : the value of current when the inductances is 30% lower than its initial value at D.C. superimposition

Note4. Irms:D.C. current when at $\Delta t = 40^{\circ}C(typ.).(Ta=25^{\circ}C)$

Note5. Packing: reel; Quantity: 1500 pcs/reel

GENERAL CHARACTERISTICS

- 1. Operating temperature range: -40 TO + 125°C(Includes temperature when the coil is heated)
- 2. External appearance: On visual inspection, the coil has no external defects.
- Terminal strength: After soldering. Between copper plate and terminals of coil. Push in two directions of X.Y withstanding at below conditions.

Terminal should not peel off. (refer to figure at right) 5. 0N 60 sec.

- 4. Insulating resistance: Over $100M\Omega$ at 100V D.C. between coil and core.
- 5. Dielectric strength: No dielectric breakdown at 100V D.C. for 1 minute between coil and core.
- 6. Temperature characteristics: Inductance coefficient (0~2,000)x10-6/°C (-25~+80°C degree Celsius), inductance deviation within±5.0%, after 96 hours.
- 7. Humidity characteristics(Moisture Resistance): Inductance deviation within ±5%, after 96 hours in 90~95% relative humidity at 40 ±2℃ and 1 hour drying under normal condition.
- 8. Vibration resistance: Inductance deviation within ±5%, after vibration for 1 hour. In each of three orientations at sweep vibration (10~55~10 Hz) with 1.5mm P-P amplitudes.
- 9. Shock resistance: Inductance deviation within ±5%, after being dropped once with 981m/s2 (100G) shock attitude upon a rubber block method shock testing machine, in three different orientations.
- 10. Resistance to Soldering Heat: 260°C, 10 seconds(See attached recommend reflow)
- 11. Storage condition: Temperature Range: 0° ~ 35° ; -40 $^{\circ}$ ~ 105 $^{\circ}$ (after PCB) , Humidity Range: 50% ~ 70% RH
- 12. Use components within 12 months. If 12 months or more have elapsed, check solderability before use.
- 13. Reflow profile recommend:

Lead-free heat endurance test

Lead-free the recommended reflow condition

